ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composit © Copyright 2005. IPC, international and Pan-Ar	Bannockb	urn, Illinois. A	ll rights reserved un tions.	nder both	This docume level parts, t	ent is a declaration	ion of the s encompasse	ubstances s all lowe	within the manufactu r level materials for w	rer listed	tem. Note: if nanufacturer	the item is an as has engineering	sembly with lower responsibility.	
1752-21.1				Form Type Distribute	orm Type * Declaration Class * istribute Class 6 - RoHS Yes/No, Homogeneous M				Homogeneous Mater	terials and Mfg Information					
Supplier Inform	ation														
Company name* Co			Company uni	Company unique ID			Unique ID Authority				Response Date*				
onsemi											2024-04-19				
Contact Name			Title - Contact				Phone - Contact*				Email -	Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative				Phone - Representative*			Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requester	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date	Pe Date Version Manufacturing Site			Weight*	UOM	Unit Type		
		FSQ500L		Power Switcher			2024-04-19		I	PBB		138.322	mg	Each	
Manufacturing I	Proccess Information	1						-					I	- I	
Terminal Plating / Grid Array Material Term			erminal Base A	rminal Base Alloy J-STD-020 MSL		L Rating	Peak Process Body Temperature Max		re Max Time at Peak	ak Temperature Number of Reflow Cycles		eles			
Matte Tin (Sn) - annealed CU Al			CU Alloy	Alloy 1			260 C		С	30	seco	nds 3			
Comments															
evel 1 - maximum til	me at peak temperature o	luring sol	dering is 10-3	0 seconds											
For more information	n regarding material con	position]	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	IS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead , Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl alate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	21.1	mg	Supplier	Silicon (Si)	7440-21-3		21.1	mg
Die Attach	1.751	mg	Supplier	Silver (Ag)	7440-22-4		1.3133	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.4378	mg
Lead Frame	66.944	mg	Supplier	Silver (Ag)	7440-22-4		0.234	mg
			Supplier	Zinc (Zn)	7440-66-6		0.08	mg
			Supplier	Iron (Fe)	7439-89-6		1.61	mg
			Supplier	Copper (Cu)	7440-50-8		65	mg
			Supplier	Phosphorus (P)	7723-14-0		0.02	mg
Mold Compound-Black	39.687	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		9.035	mg
			Supplier	Carbon Black (C)	1333-86-4		0.452	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		30.2	mg
Plating	8.29	mg	Supplier	Tin (Sn)	7440-31-5		8.29	mg
Wire Bond - Au	0.55	mg	Supplier	Gold (Au)	7440-57-5		0.55	mg